

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No. .... 10/340,126  
Priority Filing Date ..... January 10, 2003  
 Inventor ..... Zhongze Wang  
 Assignee ..... Micron Technology, Inc.  
Priority Group Art Unit ..... 2812  
Priority Examiner ..... Jennifer M. Kennedy  
 Attorney Docket No. .... MI22-2457  
 Customer No. .... 021567  
 Title: Wafer Bonding Method of Forming Silicon-on-Insulator Comprising  
 Integrated Circuitry

**INFORMATION DISCLOSURE STATEMENT**  
**PURSUANT TO 37 C.F.R. §§ 1.56, 1.97 AND 1.98**

In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, your attention is directed to the United States patents and other references listed on the attached Form PTO-1449. No admission is made regarding whether all the submitted references are prior art.

The listed references were cited by, or submitted to, the Office in the parent, co-pending application of the above-identified application. The above-identified application is a divisional application of co-pending application Serial No. 10/340,126, filed January 10, 2003. Such prior disclosure is sufficient for the above-identified application as far as copies of the references are concerned. 37 C.F.R. § 1.98(d) and MPEP § 609(2).

Citation of these references is respectfully requested.

Respectfully submitted,

Dated: 12-12-03

By: 

Mark S. Matkin  
 Reg. No. 32,268

Form PTO-1449		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY. DOCKET NO. MI22-2457		PRIORITY SERIAL NO. 10/340,126	
LIST OF ART CITED BY APPLICANT (Use several sheets if necessary)				APPLICANT: Zhongze Wang			
				PRIORITY FILING DATE January 10, 2003		PRIORITY GROUP ART UNIT 2812	

  

U.S. PATENT DOCUMENTS							
*Examiner's Initials	Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate	
	AA	5,021,843	Ohmi				
	AB	5,849,627	Linn et al.				
	AC	6,255,731 B1	Ohmi et al.				
	AD	6,410,938 B1	Xiang				
	AE	6,433,401 B1	Clark et al.				
	AF	6,610,615 B1	McFadden et al.				
	AG	2002/0134503 A1	Hussinger et al.				
	AH						
	AI						

  

FOREIGN PATENT DOCUMENTS							
	Document Number	Date	Country	Class	Subclass	Translation	
						Yes	No
	AJ						
	AK						
	AL						

  

OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)			
	AM		Bernstein et al., <i>Floating Body Effects</i> , SOI DEVICE ELECTRICAL PROPERTIES 34-53 (pre-August 2001).
	AN		
	AO		

  

EXAMINER	DATE CONSIDERED
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\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.